

100322

100322 Low Power 9-Bit Buffer



Literature Number: SNOS123A

Low Power 9-Bit Buffer

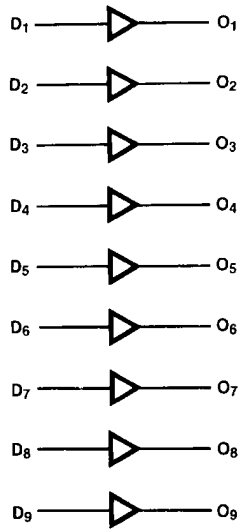
General Description

The 100322 is a monolithic 9-bit buffer. The device contains nine non-inverting buffer gates with single input and output. All inputs have 50 kΩ pull-down resistors and all outputs are buffered.

Features

- 30% power reduction of the 100122
- 2000V ESD protection
- Pin/function compatible with 100122
- Voltage compensated operating range = -4.2V to -5.7V
- Available to MIL-STD-883

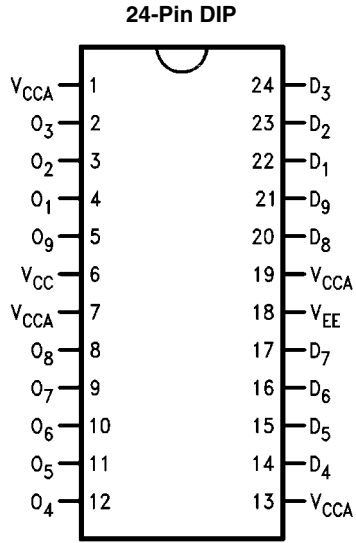
Logic Symbol



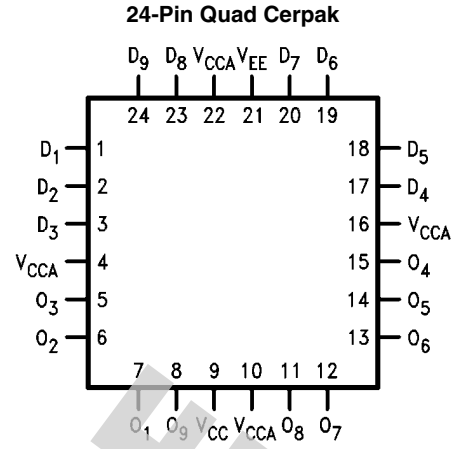
10030801

| Pin Names | Description |
|---------------------------------|--------------|
| D ₁ , D ₉ | Data Inputs |
| O ₁ , O ₉ | Data Outputs |

Connection Diagrams



10030802



10030803

OBSOLETE

Absolute Maximum Ratings *(Note 1)*

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Above which the useful life may be impaired.

| | |
|--|-------------------|
| Storage Temperature (T_{STG}) | -65°C to +150°C |
| Maximum Junction Temperature (T_J) | |
| Ceramic | +175°C |
| V_{EE} Pin Potential to Ground Pin | -7.0V to +0.5V |
| Input Voltage (DC) | V_{EE} to +0.5V |

| | |
|---------------------------------|--------|
| Output Current (DC Output HIGH) | -50 mA |
| ESD <i>(Note 2)</i> | ≥2000V |

Recommended Operating Conditions

| | |
|-----------------------------|-----------------|
| Case Temperature (T_C) | |
| Military | -55°C to +125°C |
| Supply Voltage (V_{EE}) | -5.7V to -4.2V |

Note 1: Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: ESD testing conforms to MIL-STD-883, Method 3015.

Military Version

DC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$, $T_C = -55°C$ to $+125°C$

| Symbol | Parameter | Min | Max | Units | T_C | Conditions | Notes | |
|-----------|----------------------|-------|-------|-------|-----------------|--|---|---------------------------------|
| V_{OH} | Output HIGH Voltage | -1025 | -870 | mV | 0°C to +125°C | $V_{IN} = V_{IH (Max)}$ or $V_{IL (Min)}$ | Loading with 50Ω to -2.0V | <i>(Note 3, Note 4, Note 5)</i> |
| | | -1085 | -870 | mV | -55°C | | | |
| V_{OL} | Output LOW Voltage | -1830 | -1620 | mV | 0°C to +125°C | $V_{IN} = V_{IH (Max)}$ or $V_{IL (Min)}$ | Loading with 50Ω to -2.0V | <i>(Note 3, Note 4, Note 5)</i> |
| | | -1830 | -1555 | mV | -55°C | | | |
| V_{OHC} | Output HIGH Voltage | -1035 | | mV | 0°C to +125°C | $V_{IN} = V_{IH (Max)}$ or $V_{IL (Min)}$ | Loading with 50Ω to -2.0V | <i>(Note 3, Note 4, Note 5)</i> |
| | | -1085 | | mV | -55°C | | | |
| V_{OLC} | Output LOW Voltage | | -1610 | mV | 0°C to +125°C | $V_{IN} = V_{IH (Max)}$ or $V_{IL (Min)}$ | Loading with 50Ω to -2.0V | <i>(Note 3, Note 4, Note 5)</i> |
| | | | -1555 | mV | -55°C | | | |
| V_{IH} | Input HIGH Voltage | -1165 | -870 | mV | -55°C to +125°C | Guaranteed HIGH Signal for All Inputs | <i>(Note 3, Note 4, Note 5, Note 6)</i> | |
| V_{IL} | Input HIGH Voltage | -1830 | -1475 | mV | -55°C to +125°C | Guaranteed LOW Signal for All Inputs | <i>(Note 3, Note 4, Note 5, Note 6)</i> | |
| I_{IL} | Input LOW Current | 0.50 | | μA | -55°C to +125°C | $V_{EE} = -4.2V$ $V_{IN} = V_{IL (Min)}$ | <i>(Note 3, Note 4, Note 5)</i> | |
| I_{IH} | Input HIGH Current | | 240 | μA | 0°C to +125°C | $V_{EE} = -5.7V$ $V_{IN} = V_{IH (Max)}$ | <i>(Note 3, Note 4, Note 5)</i> | |
| | | | 340 | μA | -55°C | | | |
| I_{EE} | Power Supply Current | -70 | -25 | mA | -55°C to +125°C | Inputs Open | <i>(Note 3, Note 4, Note 5)</i> | |

Note 3: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals -55°C), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

Note 4: Screen tested 100% on each device at -55°C, +25°C, and +125°C, Subgroups 1, 2, 3, 7, and 8.

Note 5: Sample tested (Method 5005, Table I) on each manufactured lot at -55°C, +25°C, and +125°C, Subgroups A1, 2, 3, 7, and 8.

Note 6: Guaranteed by applying specified input condition and testing V_{OH}/V_{OL} .

AC Electrical Characteristics

$V_{EE} = -4.2V$ to $-5.7V$, $V_{CC} = V_{CCA} = GND$

| Symbol | Parameter | $T_C = -55°C$ | | $T_C = +25°C$ | | $T_C = +125°C$ | | Units | Conditions | Notes |
|-----------|------------------------|---------------|------|---------------|------|----------------|------|-------|--------------|--|
| | | Min | Max | Min | Max | Min | Max | | | |
| t_{PLH} | Propagation Delay | 0.30 | 1.80 | 0.40 | 1.60 | 0.40 | 1.80 | ns | Figures 1, 2 | <i>(Note 7, Note 8, Note 9, Note 11)</i> |
| t_{PHL} | Data to Output | | | | | | | | | |
| t_{TLH} | Transition Time | 0.30 | 1.20 | 0.30 | 1.20 | 0.30 | 1.20 | ns | | <i>(Note 10)</i> |
| t_{THL} | 20% to 80%, 80% to 20% | | | | | | | | | |

Note 7: F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals -55°C), then testing immediately after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

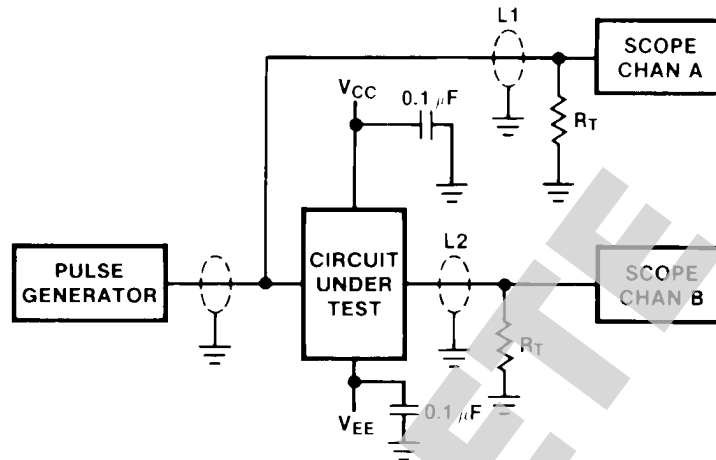
Note 8: Screen tested 100% on each device at $+25^{\circ}\text{C}$, only Subgroup A9.

Note 9: Sample tested (Method 5005, Table I) on each manufactured lot at $+25^{\circ}\text{C}$, Subgroup A9, and at $+125^{\circ}\text{C}$ and -55°C temperatures, Subgroups A10 and A11.

Note 10: Not tested at $+25^{\circ}\text{C}$, $+125^{\circ}\text{C}$, and -55°C temperature (design characterization data).

Note 11: The propagation delay specified is for single output switching. Delays may vary up to 200 ps with multiple outputs switching.

Test Circuit



10030805

Notes:

$V_{CC}, V_{CCA} = +2\text{V}, V_{EE} = -2.5\text{V}$

L1 and L2 = equal length 50Ω impedance lines

$R_T = 50\Omega$ terminator internal to scope

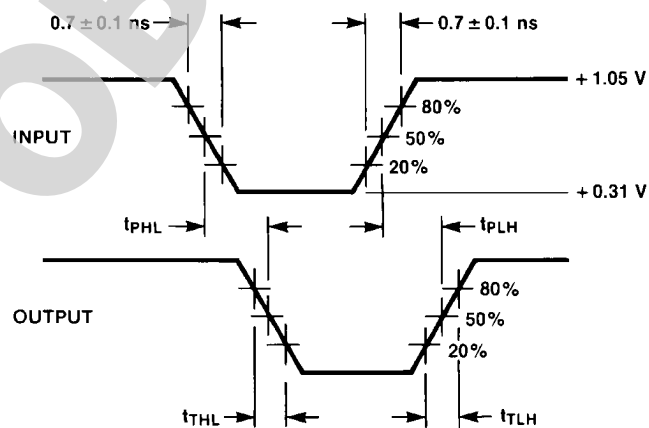
Decoupling 0.1 μF from GND to V_{CC} and V_{EE}

All unused outputs are loaded with 50Ω to GND

C_L = Fixture and stray capacitance ≤ 3 pF

FIGURE 1. AC Test Circuit

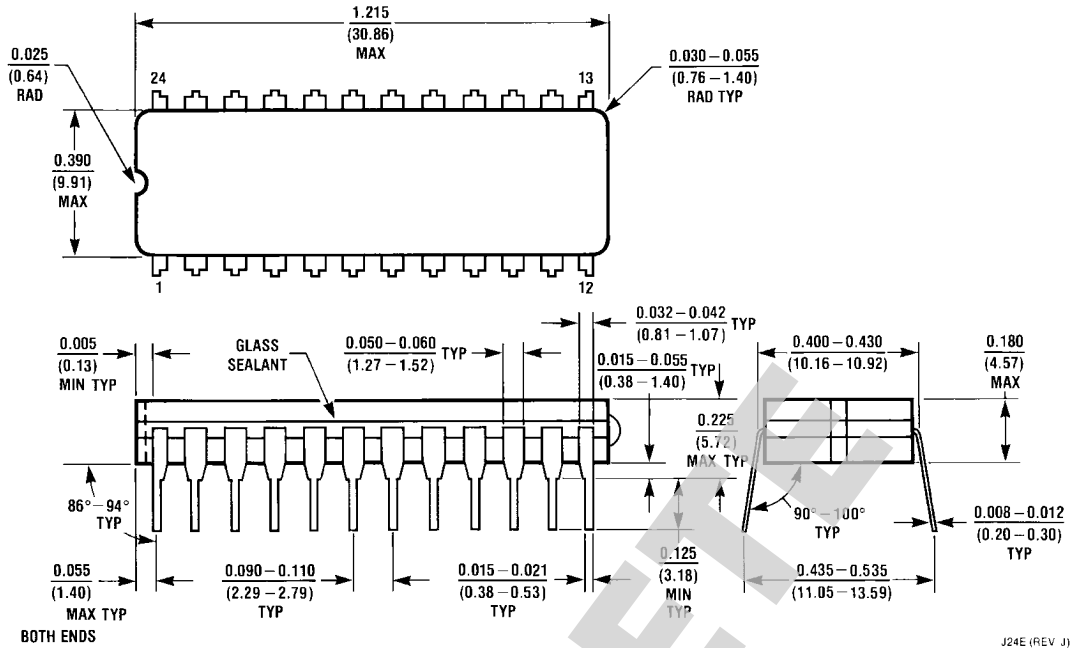
Switching Waveforms



10030806

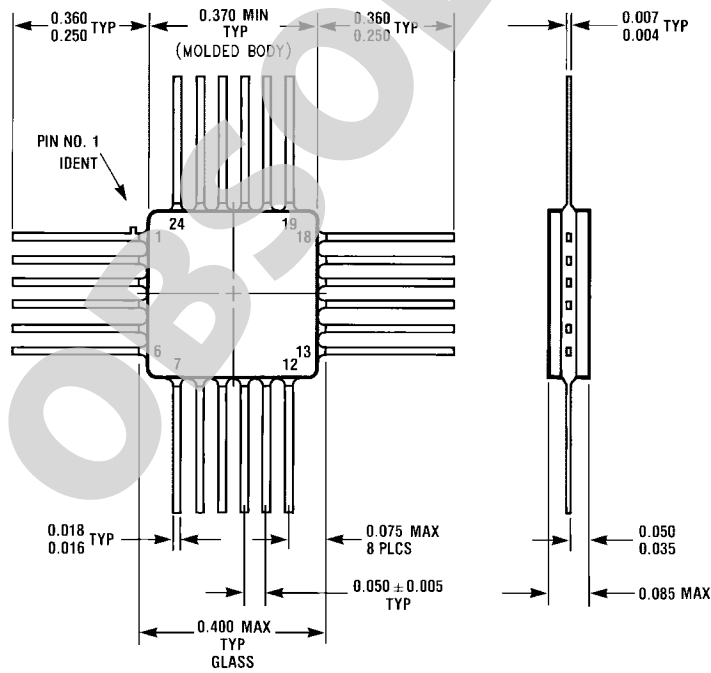
FIGURE 2. Propagation Delay and Transition Times

Physical Dimensions inches (millimeters) unless otherwise noted



24-Lead Ceramic Dual-In-Line Package (0.400 Wide) (D)
NS Package Number J24E

J24E (REV J)



24-Lead Ceramic Flatpak (F)
NS Package Number W24B

W24B (REV D)

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